

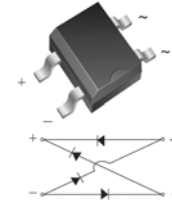
# Surface Mount Bridge Rectifiers

## PRODUCT SUMMARY

Miniature Glass Passivated Single-Phase  
Reverse Voltage 200 to 1000 Volts

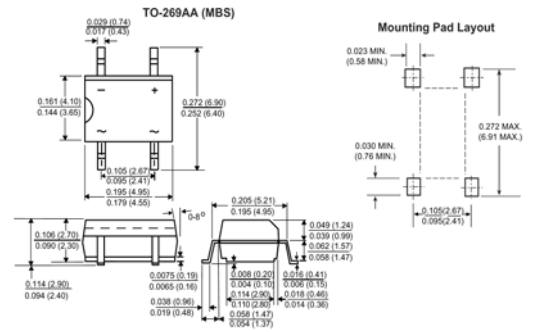
## FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Glass passivated chip junctions
- High surge overload rating: 35A peak
- Saves space on printed circuit boards
- High temperature soldering guaranteed: 260°C/10 seconds



## MECHANICAL DATA

- Case: Molded plastic body over passivated junctions
- Terminals: Plated leads solderable per MIL-STD-750, Method 2026
- Mounting Position: Any
- Weight: 0.078 oz., 0.22 g



## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

( $T_A=25^{\circ}\text{C}$  unless otherwise noted)

Parameter	Symbols	MB2S	MB4S	MB6S	MB8S	MB10S	Units
Maximum repetitive peak reverse voltage	$V_{RRM}$	200	400	600	800	1000	Volts
Maximum RMS voltage	$V_{RMS}$	140	280	420	560	700	Volts
Maximum DC blocking voltage	$V_{DC}$	200	400	600	800	1000	Volts
Maximum average forward output rectified current (see Fig.1) on glass-epoxy P.C.B. on aluminum substrate	$I_{F(AV)}$	0.5 <sup>(1)</sup> 0.8 <sup>(2)</sup>					Amp
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	35.0					Amps
Rating for fusing ( $t < 8.3\text{ms}$ )	$I^2t$	5.0					$\text{A}^2\text{sec}$
Maximum instantaneous forward voltage drop per leg at 0.4A	$V_F$	1.0					Volt
Maximum DC reverse current at rated DC blocking voltage per leg	$I_R$	5.0 100					$\mu\text{A}$
Typical thermal resistance per leg	$R_{\theta JA}$	85 <sup>(1)</sup>					$^{\circ}\text{C/W}$
	$R_{\theta SA}$	70 <sup>(2)</sup>					
	$R_{\theta JL}$	20 <sup>(1)</sup>					
Typical junction capacitance per leg at 4.0V, 1.0MHz	$C_J$	13					pF
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +150					$^{\circ}\text{C}$

- Notes:**
1. On glass epoxy P.C.B. mounted on 0.05 x 0.05" (1.3 x 1.3mm) pads
  2. On aluminum substrate P.C.B. with an area of 0.8" x 0.8" (20 x 20mm) mounted on 0.05 x 0.05" (1.3 x 1.3mm) solder pad

## RATINGS AND CHARACTERISTIC CURVES

( $T_A=25^{\circ}\text{C}$  unless otherwise noted)

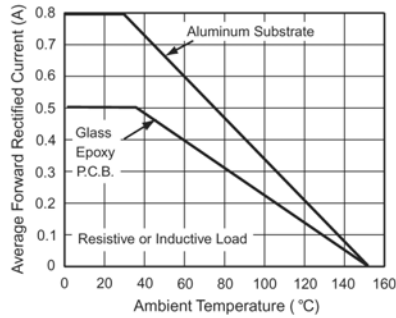


Figure 1. Derating Curve for Output Rectified Current

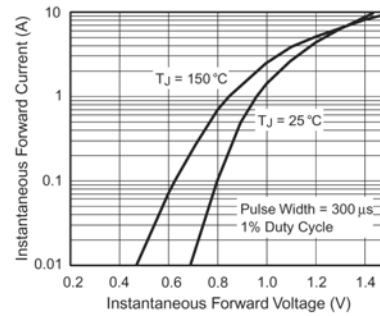


Figure 3. Typical Forward Voltage Characteristics Per Leg

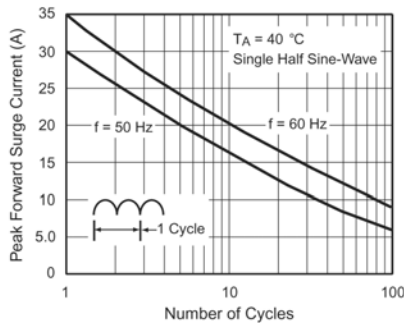


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current Per Leg

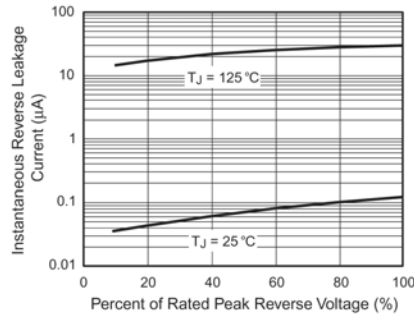


Figure 4. Typical Reverse Leakage Characteristics Per Leg

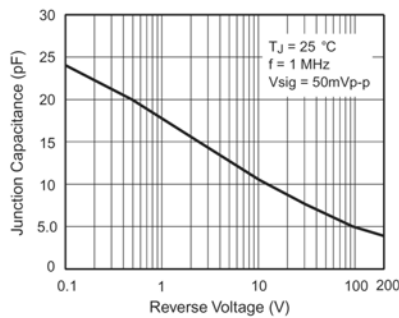


Figure 5. Typical Junction Capacitance Per Leg

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